







IFN6449, IFN6450 N-Channel JFET

Features

- InterFET N0042SY Geometry
- · High Voltage
- Low Input Capacitance: 3pF Maximum
- RoHS Compliant
- SMT, TH, and Bare Die Package options.

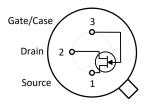
Applications

· High Voltage

Description

The -300V InterFET IFN6449 and IFN6450 are targeted for high voltage applications. The TO-39 package is hermetically sealed and suitable for military applications.

TO-39 Bottom View





Product Summary

Parameters		IFN6449 Min	IFN6450 Min	Unit			
BV _{GSS}	Gate to Source Breakdown Voltage	-100	-100	V			
I _{DSS}	Drain to Source Saturation Current	2	2	mA			
$V_{GS(off)}$	Gate to Source Cutoff Voltage	-2	-2	V			
GFS	Forward Transconductance	0.5	0.5	mS			

Ordering Information Custom Part and Binning Options Available

Part Number	Description	Case	Packaging
IFN6449; IFN6450	Through-Hole	TO-39	Bulk
IFN6449COT; IFN6450COT	Chip Orientated Tray (COT Waffle Pack)	СОТ	400/Waffle Pack
IFN6449CFT; IFN6450CFT	Chip Face-up Tray (CFT Waffle Pack)	CFT	400/Waffle Pack



Disclaimer: It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.









Electrical Characteristics

Maximum Ratings (@ T_A = 25°C, Unless otherwise specified)

	Parameters	Value	Unit
V_{RGS}	Reverse Gate Drain Voltage	-300; -200	V
I _{FG}	Continuous Forward Gate Current	10	mA
PD	Continuous Device Power Dissipation	800	mW
Р	Power Derating	6.4	mW/°C
Tı	Operating Junction Temperature	-55 to 125	°C
T _{STG}	Storage Temperature	-65 to 200	°C

Static Characteristics (@ TA = 25°C, Unless otherwise specified)

			IFN6449		IFN6450		
	Parameters	Conditions	Min	Max	Min	Max	Unit
V _{(BR)GSS}	Gate to Source Breakdown Voltage	I _G = -10μΑ, I _D = 0Α	-100		-100		V
V _{(BR)GDO}	Gate Drain Breakdown Voltage	I _G = -10μΑ, I _S = 0Α	-300		-200		V
I _{GSS}	Gate to Source Reverse Current	$V_{GS} = -80V$, $V_{DS} = 0V$, $T_A = 25$ °C $V_{GS} = -80V$, $V_{DS} = 0V$, $T_A = 150$ °C				-100 -100	nA μA
V _{GS(OFF)}	Gate to Source Cutoff Voltage	V _{DS} = 30V, I _D = 4nA	-2	-15	-2	-15	V
I _{DSS}	Drain to Source Saturation Current	$V_{GS} = 0V$, $V_{DS} = 30V$ (Pulsed)	2	10	2	10	mA

Dynamic Characteristics (@ TA = 25°C, Unless otherwise specIFNied)

			IFN6449		IFN6450		
	Parameters	Conditions	Min	Max	Min	Max	Unit
GFS	Forward Transconductance	V _{DS} = 30V, V _{GS} = 0V, f = 1kHz	0.5	3	0.5	3	mS
Gos	Output Conductance	V _{DS} = 30V, V _{GS} = 0V, f = 1kHz		100		100	μS
Ciss	Input Capacitance	V _{DS} = 30V, V _{GS} = 0V, f = 1MHz		3		3	pF
Crss	Reverse Transfer Capacitance	V _{DS} = 30V, V _{GS} = 0V, f = 1MHz		0.6		0.6	pF